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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf877-04i-p

At the completion of the write cycle, the WR bit is cleared and the EEIF interrupt flag bit is set. (EEIF must be cleared by firmware.) Since the microcontroller does not execute instructions during the write cycle, the firmware does not necessarily have to check either EEIF, or WR, to determine if the write had finished.

EXAMPLE 4-4: FLASH PROGRAM WRITE

```
BSF    STATUS, RP1    ;
BCF    STATUS, RP0    ;Bank 2
MOVF   ADDR1, W       ;Write address
MOVWF  EEADR          ;of desired
MOVF   ADDR2, W       ;program memory
MOVWF  EEADRH         ;location
MOVF   VAL1, W        ;Write value to
MOVWF  EEDATA         ;program at
MOVF   VAL2, W        ;desired memory
MOVWF  EEDATH         ;location
BSF    STATUS, RP0    ;Bank 3
BSF    EECON1, EEPGD  ;Point to Program memory
BSF    EECON1, WREN   ;Enable writes
        ;Only disable interrupts
BCF    INTCON, GIE    ;if already enabled,
        ;otherwise discard
MOVLW  0x55           ;Write 55h to
MOVWF  EECON2         ;EECON2
MOVLW  0xAA           ;Write AAh to
MOVWF  EECON2         ;EECON2
BSF    EECON1, WR     ;Start write operation
NOP    ;Two NOPs to allow micro
NOP    ;to setup for write
        ;Only enable interrupts
BSF    INTCON, GIE    ;if using interrupts,
        ;otherwise discard
BCF    EECON1, WREN   ;Disable writes
```

4.6 Write Verify

The PIC16F87X devices do not automatically verify the value written during a write operation. Depending on the application, good programming practice may dictate that the value written to memory be verified against the original value. This should be used in applications where excessive writes can stress bits near the specified endurance limits.

4.7 Protection Against Spurious Writes

There are conditions when the device may not want to write to the EEPROM data memory or FLASH program memory. To protect against these spurious write conditions, various mechanisms have been built into the PIC16F87X devices. On power-up, the WREN bit is cleared and the Power-up Timer (if enabled) prevents writes.

The write initiate sequence, and the WREN bit together, help prevent any accidental writes during brown-out, power glitches, or firmware malfunction.

4.8 Operation While Code Protected

The PIC16F87X devices have two code protect mechanisms, one bit for EEPROM data memory and two bits for FLASH program memory. Data can be read and written to the EEPROM data memory, regardless of the state of the code protection bit, CPD. When code protection is enabled and CPD cleared, external access via ICSP is disabled, regardless of the state of the program memory code protect bits. This prevents the contents of EEPROM data memory from being read out of the device.

The state of the program memory code protect bits, CP0 and CP1, do not affect the execution of instructions out of program memory. The PIC16F87X devices can always read the values in program memory, regardless of the state of the code protect bits. However, the state of the code protect bits and the WRT bit will have different effects on writing to program memory. Table 4-1 shows the effect of the code protect bits and the WRT bit on program memory.

Once code protection has been enabled for either EEPROM data memory or FLASH program memory, only a full erase of the entire device will disable code protection.

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6.7 Resetting of Timer1 Register Pair (TMR1H, TMR1L)

TMR1H and TMR1L registers are not reset to 00h on a POR, or any other RESET, except by the CCP1 and CCP2 special event triggers.

T1CON register is reset to 00h on a Power-on Reset, or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescale. In all other RESETS, the register is unaffected.

6.8 Timer1 Prescaler

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

TABLE 6-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
0Eh	TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	--00 0000	--uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

Note 1: Bits PSPIE and PSPIF are reserved on the PIC16F873/876; always maintain these bits clear.

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REGISTER 9-3: SSPCON2: SYNC SERIAL PORT CONTROL REGISTER2 (ADDRESS 91h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN

bit 7

bit 0

- bit 7 **GCEN:** General Call Enable bit (In I²C Slave mode only)
1 = Enable interrupt when a general call address (0000h) is received in the SSPSR
0 = General call address disabled
- bit 6 **ACKSTAT:** Acknowledge Status bit (In I²C Master mode only)
In Master Transmit mode:
1 = Acknowledge was not received from slave
0 = Acknowledge was received from slave
- bit 5 **ACKDT:** Acknowledge Data bit (In I²C Master mode only)
In Master Receive mode:
Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.
1 = Not Acknowledge
0 = Acknowledge
- bit 4 **ACKEN:** Acknowledge Sequence Enable bit (In I²C Master mode only)
In Master Receive mode:
1 = Initiate Acknowledge sequence on SDA and SCL pins and transmit ACKDT data bit.
Automatically cleared by hardware.
0 = Acknowledge sequence idle
- bit 3 **RCEN:** Receive Enable bit (In I²C Master mode only)
1 = Enables Receive mode for I²C
0 = Receive idle
- bit 2 **PEN:** STOP Condition Enable bit (In I²C Master mode only)
SCK Release Control:
1 = Initiate STOP condition on SDA and SCL pins. Automatically cleared by hardware.
0 = STOP condition idle
- bit 1 **RSEN:** Repeated START Condition Enable bit (In I²C Master mode only)
1 = Initiate Repeated START condition on SDA and SCL pins. Automatically cleared by hardware.
0 = Repeated START condition idle
- bit 0 **SEN:** START Condition Enable bit (In I²C Master mode only)
1 = Initiate START condition on SDA and SCL pins. Automatically cleared by hardware.
0 = START condition idle

Note: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I²C module is not in the IDLE mode, this bit may not be set (no spooling), and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

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9.2.15 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit, or Repeated START/STOP condition, de-asserts the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the baud rate generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 9-18).

9.2.16 SLEEP OPERATION

While in SLEEP mode, the I²C module can receive addresses or data, and when an address match or complete byte transfer occurs, wake the processor from SLEEP (if the SSP interrupt is enabled).

9.2.17 EFFECTS OF A RESET

A RESET disables the SSP module and terminates the current transfer.

FIGURE 9-18: CLOCK ARBITRATION TIMING IN MASTER TRANSMIT MODE

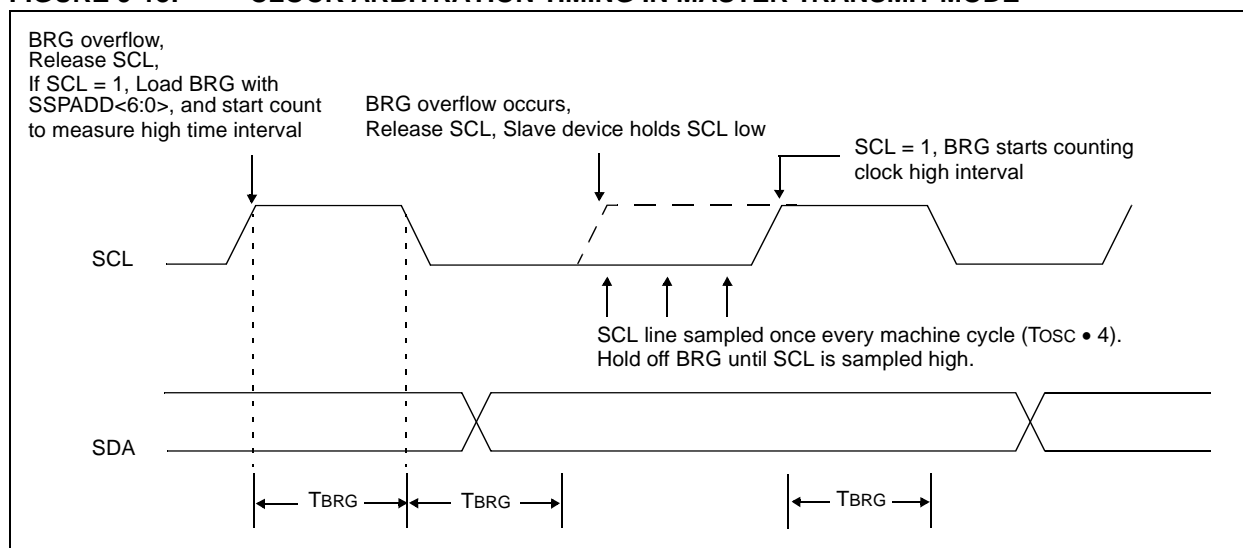


FIGURE 9-21: BUS COLLISION DURING START CONDITION (SCL = 0)

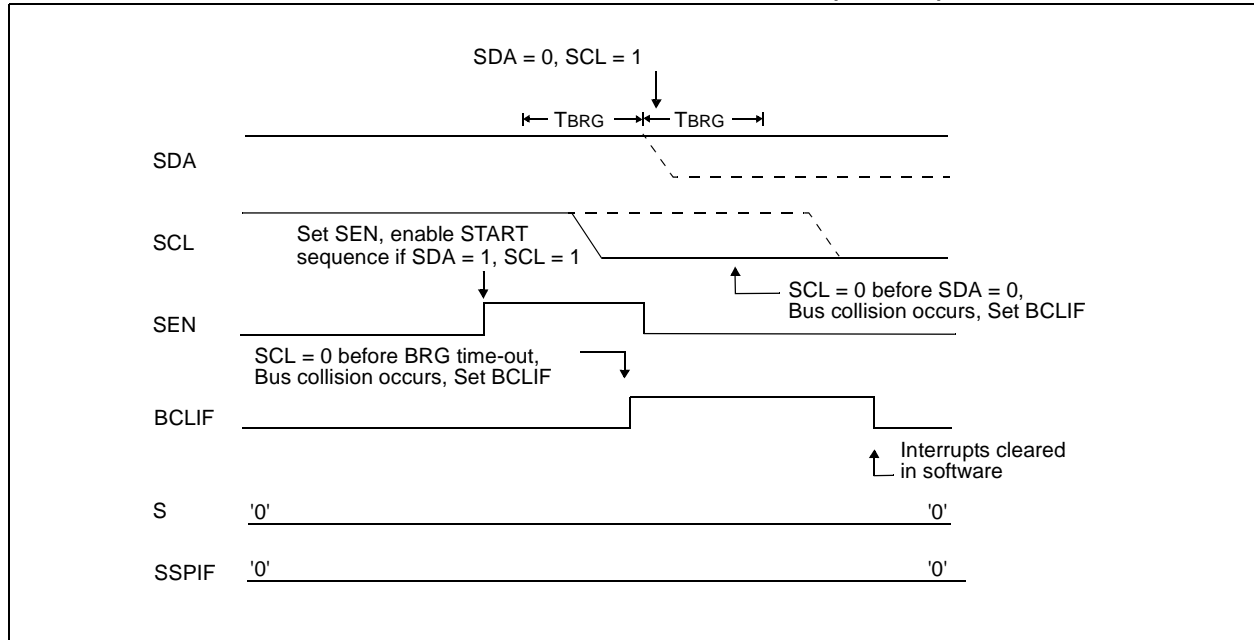
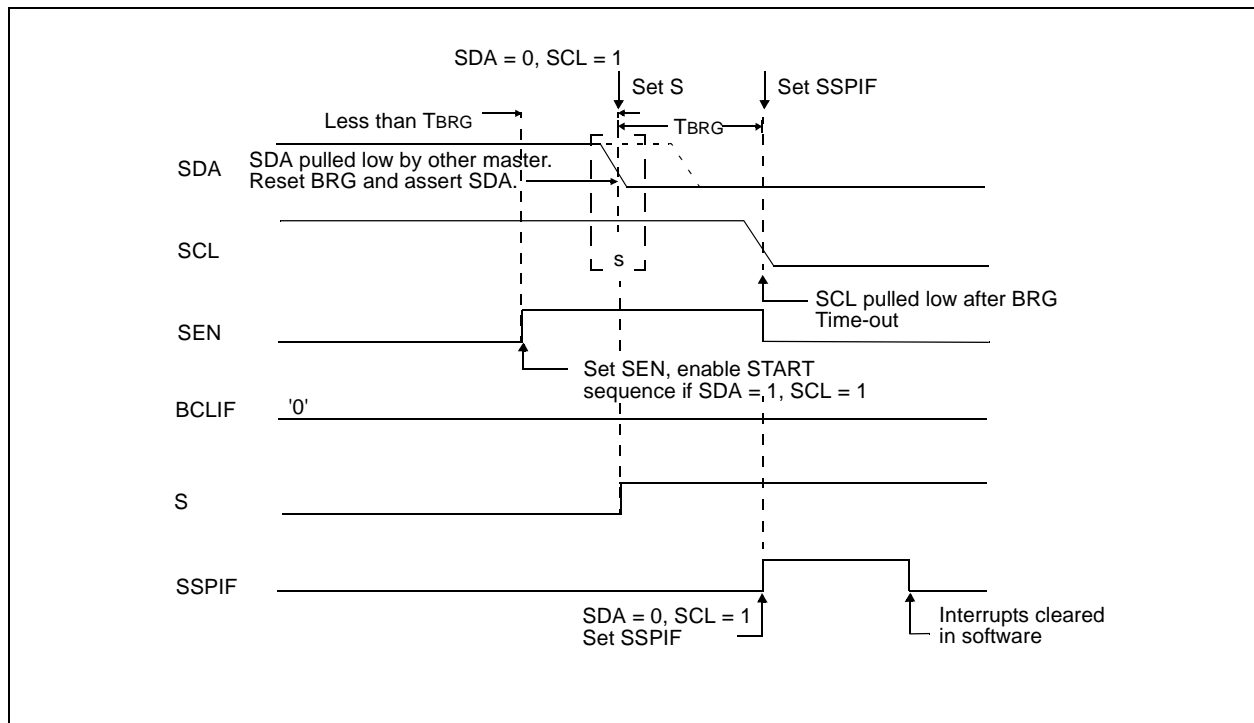


FIGURE 9-22: BRG RESET DUE TO SDA COLLISION DURING START CONDITION



11.0 ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module has five inputs for the 28-pin devices and eight for the other devices.

The analog input charges a sample and hold capacitor. The output of the sample and hold capacitor is the input into the converter. The converter then generates a digital result of this analog level via successive approximation. The A/D conversion of the analog input signal results in a corresponding 10-bit digital number. The A/D module has high and low voltage reference input that is software selectable to some combination of VDD, Vss, RA2, or RA3.

The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in SLEEP, the A/D clock must be derived from the A/D's internal RC oscillator.

The A/D module has four registers. These registers are:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register0 (ADCON0)
- A/D Control Register1 (ADCON1)

The ADCON0 register, shown in Register 11-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 11-2, configures the functions of the port pins. The port pins can be configured as analog inputs (RA3 can also be the voltage reference), or as digital I/O.

Additional information on using the A/D module can be found in the PIC® MCU Mid-Range Family Reference Manual (DS33023).

REGISTER 11-1: ADCON0 REGISTER (ADDRESS: 1Fh)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0
ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/DONE	—	ADON
bit 7							bit 0

bit 7-6	ADCS1:ADCS0: A/D Conversion Clock Select bits 00 = Fosc/2 01 = Fosc/8 10 = Fosc/32 11 = FRC (clock derived from the internal A/D module RC oscillator)
bit 5-3	CHS2:CHS0: Analog Channel Select bits 000 = channel 0, (RA0/AN0) 001 = channel 1, (RA1/AN1) 010 = channel 2, (RA2/AN2) 011 = channel 3, (RA3/AN3) 100 = channel 4, (RA5/AN4) 101 = channel 5, (RE0/AN5) ⁽¹⁾ 110 = channel 6, (RE1/AN6) ⁽¹⁾ 111 = channel 7, (RE2/AN7) ⁽¹⁾
bit 2	GO/DONE: A/D Conversion Status bit <u>If ADON = 1:</u> 1 = A/D conversion in progress (setting this bit starts the A/D conversion) 0 = A/D conversion not in progress (this bit is automatically cleared by hardware when the A/D conversion is complete)
bit 1	Unimplemented: Read as '0'
bit 0	ADON: A/D On bit 1 = A/D converter module is operating 0 = A/D converter module is shut-off and consumes no operating current

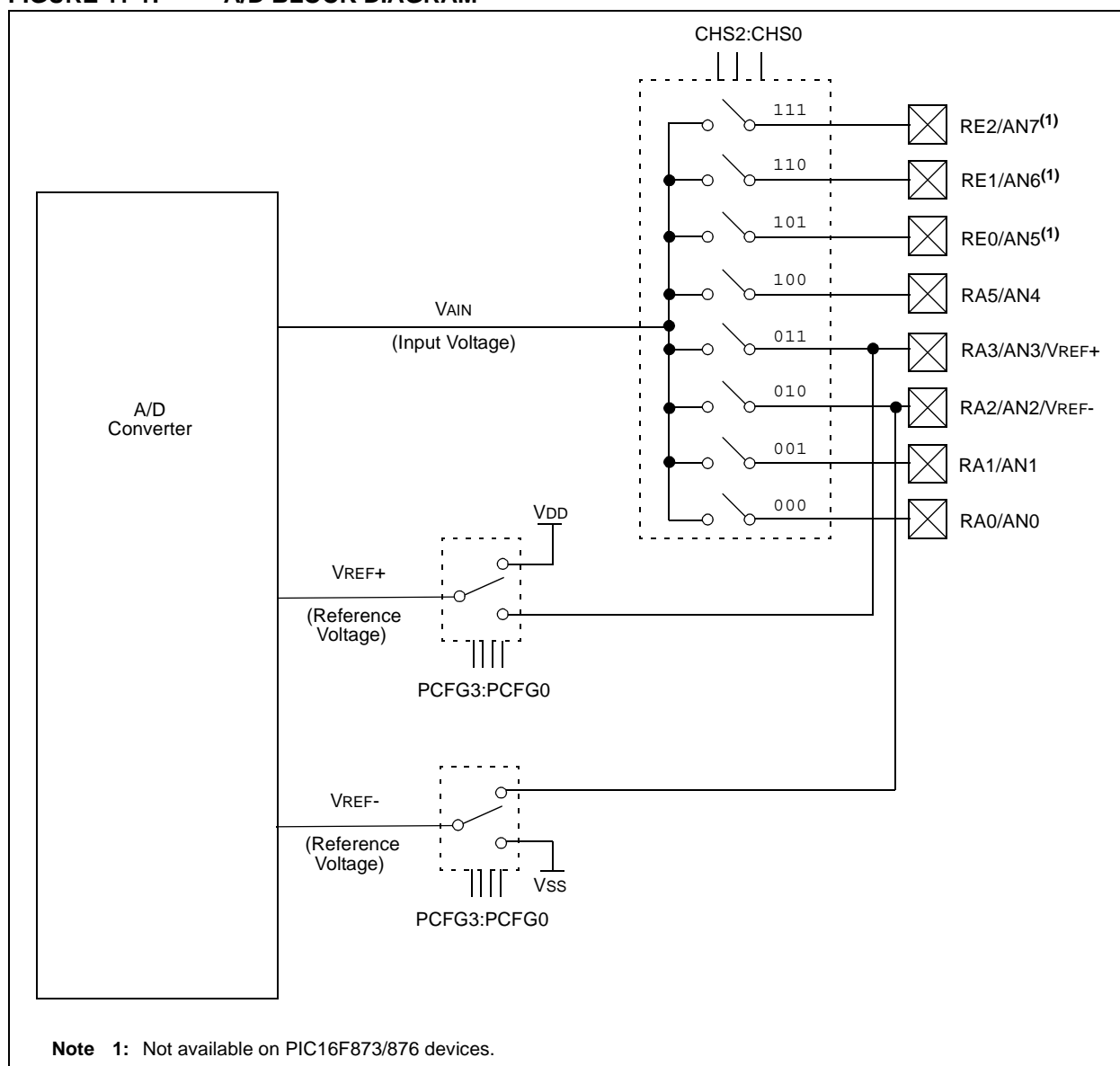
Note 1: These channels are not available on PIC16F873/876 devices.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

These steps should be followed for doing an A/D Conversion:

1. Configure the A/D module:
 - Configure analog pins/voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D conversion clock (ADCON0)
 - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
 - Clear ADIF bit
 - Set ADIE bit
 - Set PEIE bit
 - Set GIE bit
3. Wait the required acquisition time.
4. Start conversion:
 - Set GO/DONE bit (ADCON0)
5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared (with interrupts enabled); OR
 - Waiting for the A/D interrupt
6. Read A/D result register pair (ADRESH:ADRESL), clear bit ADIF if required.
7. For the next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as T_{AD}. A minimum wait of 2T_{AD} is required before the next acquisition starts.

FIGURE 11-1: A/D BLOCK DIAGRAM



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11.4 A/D Conversions

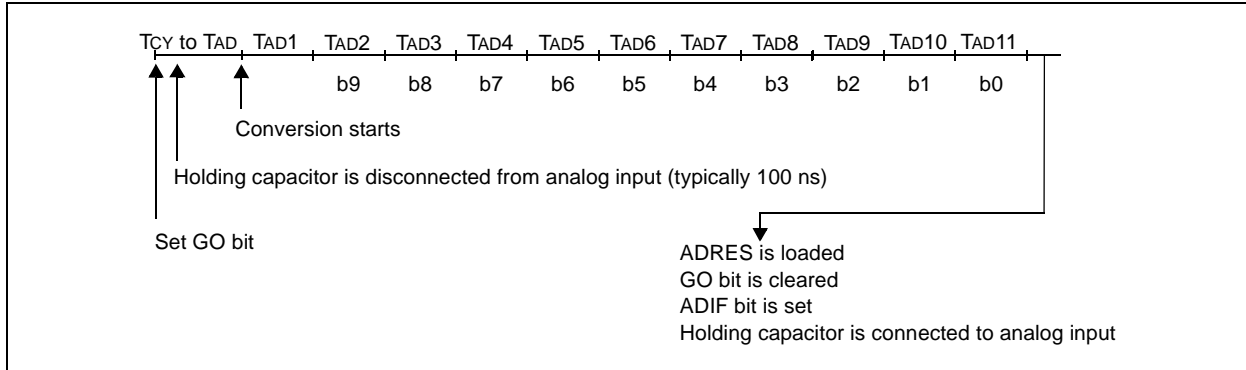
Clearing the $\overline{\text{GO/DONE}}$ bit during a conversion will abort the current conversion. The A/D result register pair will NOT be updated with the partially completed A/D conversion sample. That is, the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers). After the A/D conversion is aborted, a 2TAD wait is required before the next

acquisition is started. After this 2TAD wait, acquisition on the selected channel is automatically started. The $\overline{\text{GO/DONE}}$ bit can then be set to start the conversion.

In Figure 11-3, after the GO bit is set, the first time segment has a minimum of TCY and a maximum of TAD.

Note: The $\overline{\text{GO/DONE}}$ bit should **NOT** be set in the same instruction that turns on the A/D.

FIGURE 11-3: A/D CONVERSION TAD CYCLES

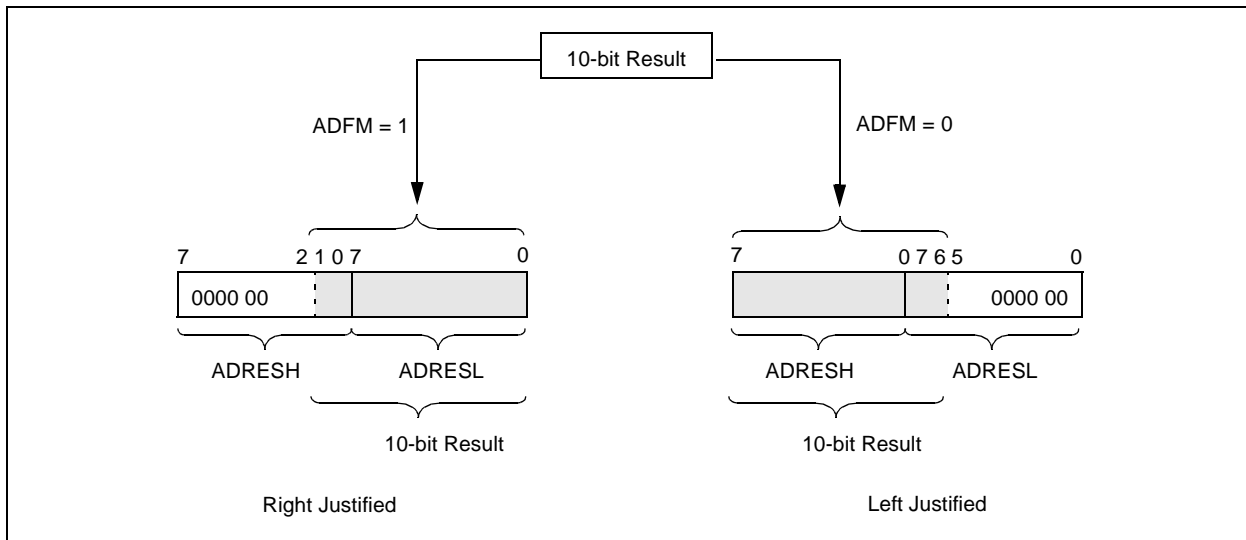


11.4.1 A/D RESULT REGISTERS

The ADRESH:ADRESL register pair is the location where the 10-bit A/D result is loaded at the completion of the A/D conversion. This register pair is 16-bits wide. The A/D module gives the flexibility to left or right justify the 10-bit result in the 16-bit result register. The A/D

Format Select bit (ADFM) controls this justification. Figure 11-4 shows the operation of the A/D result justification. The extra bits are loaded with '0's'. When an A/D result will not overwrite these locations (A/D disable), these registers may be used as two general purpose 8-bit registers.

FIGURE 11-4: A/D RESULT JUSTIFICATION



12.0 SPECIAL FEATURES OF THE CPU

All PIC16F87X devices have a host of features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- Oscillator Selection
- RESET
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code Protection
- ID Locations
- In-Circuit Serial Programming
- Low Voltage In-Circuit Serial Programming
- In-Circuit Debugger

PIC16F87X devices have a Watchdog Timer, which can be shut-off only through configuration bits. It runs off its own RC oscillator for added reliability.

There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only. It is designed to keep the part in RESET while the power supply stabilizes. With these two timers on-chip, most applications need no external RESET circuitry.

SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer Wake-up, or through an interrupt.

Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits is used to select various options.

Additional information on special features is available in the PIC[®] MCU Mid-Range Reference Manual, (DS33023).

12.1 Configuration Bits

The configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. The erased, or unprogrammed value of the configuration word is 3FFFh. These bits are mapped in program memory location 2007h.

It is important to note that address 2007h is beyond the user program memory space, which can be accessed only during programming.

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12.4 Power-On Reset (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.2V - 1.7V). To take advantage of the POR, tie the $\overline{\text{MCLR}}$ pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset. A maximum rise time for VDD is specified. See Electrical Specifications for details.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature,...) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met. Brown-out Reset may be used to meet the start-up conditions. For additional information, refer to Application Note, AN007, "Power-up Trouble Shooting", (DS00007).

12.5 Power-up Timer (PWRT)

The Power-up Timer provides a fixed 72 ms nominal time-out on power-up only from the POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. The PWRT's time delay allows VDD to rise to an acceptable level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip to chip due to VDD, temperature and process variation. See DC parameters for details (TPWRT, parameter #33).

12.6 Oscillator Start-up Timer (OST)

The Oscillator Start-up Timer (OST) provides a delay of 1024 oscillator cycles (from OSC1 input) after the PWRT delay is over (if PWRT is enabled). This helps to ensure that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or Wake-up from SLEEP.

12.7 Brown-out Reset (BOR)

The configuration bit, BODEN, can enable or disable the Brown-out Reset circuit. If VDD falls below VBOR (parameter D005, about 4V) for longer than TBOR (parameter #35, about 100 μ S), the brown-out situation will reset the device. If VDD falls below VBOR for less than TBOR, a RESET may not occur.

Once the brown-out occurs, the device will remain in Brown-out Reset until VDD rises above VBOR. The Power-up Timer then keeps the device in RESET for TPWRT (parameter #33, about 72ms). If VDD should fall below VBOR during TPWRT, the Brown-out Reset process will restart when VDD rises above VBOR with the Power-up Timer Reset. The Power-up Timer is always enabled when the Brown-out Reset circuit is enabled, regardless of the state of the PWRT configuration bit.

12.8 Time-out Sequence

On power-up, the time-out sequence is as follows: The PWRT delay starts (if enabled) when a POR Reset occurs. Then OST starts counting 1024 oscillator cycles when PWRT ends (LP, XT, HS). When the OST ends, the device comes out of RESET.

If $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Bringing $\overline{\text{MCLR}}$ high will begin execution immediately. This is useful for testing purposes or to synchronize more than one PIC16F87X device operating in parallel.

Table 12-5 shows the RESET conditions for the STATUS, PCON and PC registers, while Table 12-6 shows the RESET conditions for all the registers.

12.9 Power Control/Status Register (PCON)

The Power Control/Status Register, PCON, has up to two bits depending upon the device.

Bit0 is Brown-out Reset Status bit, $\overline{\text{BOR}}$. Bit $\overline{\text{BOR}}$ is unknown on a Power-on Reset. It must then be set by the user and checked on subsequent RESETS to see if bit $\overline{\text{BOR}}$ cleared, indicating a BOR occurred. When the Brown-out Reset is disabled, the state of the $\overline{\text{BOR}}$ bit is unpredictable and is, therefore, not valid at any time.

Bit1 is $\overline{\text{POR}}$ (Power-on Reset Status bit). It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

TABLE 12-3: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power-up		Brown-out	Wake-up from SLEEP
	$\overline{\text{PWRTE}} = 0$	$\overline{\text{PWRTE}} = 1$		
XT, HS, LP	72 ms + 1024TOSC	1024TOSC	72 ms + 1024TOSC	1024TOSC
RC	72 ms	—	72 ms	—

12.13 Power-down Mode (SLEEP)

Power-down mode is entered by executing a `SLEEP` instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the `PD` bit (`STATUS<3>`) is cleared, the `TO` (`STATUS<4>`) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the `SLEEP` instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either `VDD` or `VSS`, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D and disable external clocks. Pull all I/O pins that are hi-impedance inputs, high or low externally, to avoid switching currents caused by floating inputs. The `T0CKI` input should also be at `VDD` or `VSS` for lowest current consumption. The contribution from on-chip pull-ups on `PORTB` should also be considered.

The `MCLR` pin must be at a logic high level (`VIHMC`).

12.13.1 WAKE-UP FROM SLEEP

The device can wake-up from `SLEEP` through one of the following events:

1. External `RESET` input on `MCLR` pin.
2. Watchdog Timer Wake-up (if `WDT` was enabled).
3. Interrupt from `INT` pin, `RB` port change or peripheral interrupt.

External `MCLR` Reset will cause a device `RESET`. All other events are considered a continuation of program execution and cause a “wake-up”. The `TO` and `PD` bits in the `STATUS` register can be used to determine the cause of device `RESET`. The `PD` bit, which is set on power-up, is cleared when `SLEEP` is invoked. The `TO` bit is cleared if a `WDT` time-out occurred and caused wake-up.

The following peripheral interrupts can wake the device from `SLEEP`:

1. `PSP` read or write (`PIC16F874/877` only).
2. `TMR1` interrupt. `Timer1` must be operating as an asynchronous counter.
3. `CCP` Capture mode interrupt.
4. Special event trigger (`Timer1` in Asynchronous mode using an external clock).
5. `SSP` (`START/STOP`) bit detect interrupt.
6. `SSP` transmit or receive in Slave mode (`SPI/I2C`).
7. `USART` `RX` or `TX` (Synchronous Slave mode).
8. A/D conversion (when A/D clock source is `RC`).
9. `EEPROM` write operation completion

Other peripherals cannot generate interrupts since during `SLEEP`, no on-chip clocks are present.

When the `SLEEP` instruction is being executed, the next instruction (`PC + 1`) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the `GIE` bit. If the `GIE` bit is clear (disabled), the device continues execution at the instruction after the `SLEEP` instruction. If the `GIE` bit is set (enabled), the device executes the instruction after the `SLEEP` instruction and then branches to the interrupt address (`0004h`). In cases where the execution of the instruction following `SLEEP` is not desirable, the user should have a `NOP` after the `SLEEP` instruction.

12.13.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (`GIE` cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a `SLEEP` instruction, the `SLEEP` instruction will complete as a `NOP`. Therefore, the `WDT` and `WDT` postscaler will not be cleared, the `TO` bit will not be set and `PD` bits will not be cleared.
- If the interrupt occurs **during or after** the execution of a `SLEEP` instruction, the device will immediately wake-up from `SLEEP`. The `SLEEP` instruction will be completely executed before the wake-up. Therefore, the `WDT` and `WDT` postscaler will be cleared, the `TO` bit will be set and the `PD` bit will be cleared.

Even if the flag bits were checked before executing a `SLEEP` instruction, it may be possible for flag bits to become set before the `SLEEP` instruction completes. To determine whether a `SLEEP` instruction executed, test the `PD` bit. If the `PD` bit is set, the `SLEEP` instruction was executed as a `NOP`.

To ensure that the `WDT` is cleared, a `CLRWDT` instruction should be executed before a `SLEEP` instruction.

DECFSZ Decrement f, Skip if 0

Syntax: [*label*] DECFSZ f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(f) - 1 \rightarrow (\text{destination})$;
skip if result = 0

Status Affected: None

Description: The contents of register 'f' are decremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.
If the result is 1, the next instruction is executed. If the result is 0, then a NOP is executed instead making it a 2TCY instruction.

INCFSZ Increment f, Skip if 0

Syntax: [*label*] INCFSZ f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{destination})$,
skip if result = 0

Status Affected: None

Description: The contents of register 'f' are incremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.
If the result is 1, the next instruction is executed. If the result is 0, a NOP is executed instead, making it a 2TCY instruction.

GOTO Unconditional Branch

Syntax: [*label*] GOTO k

Operands: $0 \leq k \leq 2047$

Operation: $k \rightarrow \text{PC}<10:0>$
 $\text{PCLATH}<4:3> \rightarrow \text{PC}<12:11>$

Status Affected: None

Description: GOTO is an unconditional branch. The eleven-bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two-cycle instruction.

IORLW Inclusive OR Literal with W

Syntax: [*label*] IORLW k

Operands: $0 \leq k \leq 255$

Operation: $(W) .OR. k \rightarrow (W)$

Status Affected: Z

Description: The contents of the W register are OR'ed with the eight bit literal 'k'. The result is placed in the W register.

INCF Increment f

Syntax: [*label*] INCF f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{destination})$

Status Affected: Z

Description: The contents of register 'f' are incremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.

IORWF Inclusive OR W with f

Syntax: [*label*] IORWF f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(W) .OR. (f) \rightarrow (\text{destination})$

Status Affected: Z

Description: Inclusive OR the W register with register 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.

FIGURE 15-3: PIC16F87X-04 VOLTAGE-FREQUENCY GRAPH (ALL TEMPERATURE RANGES)

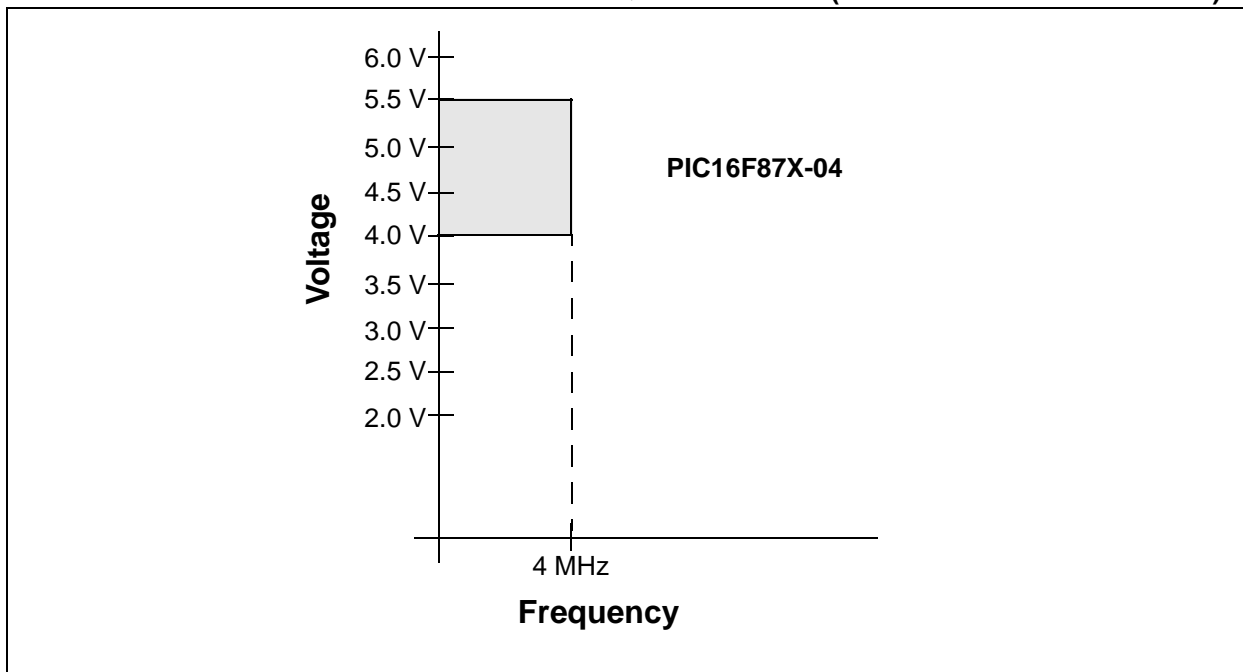
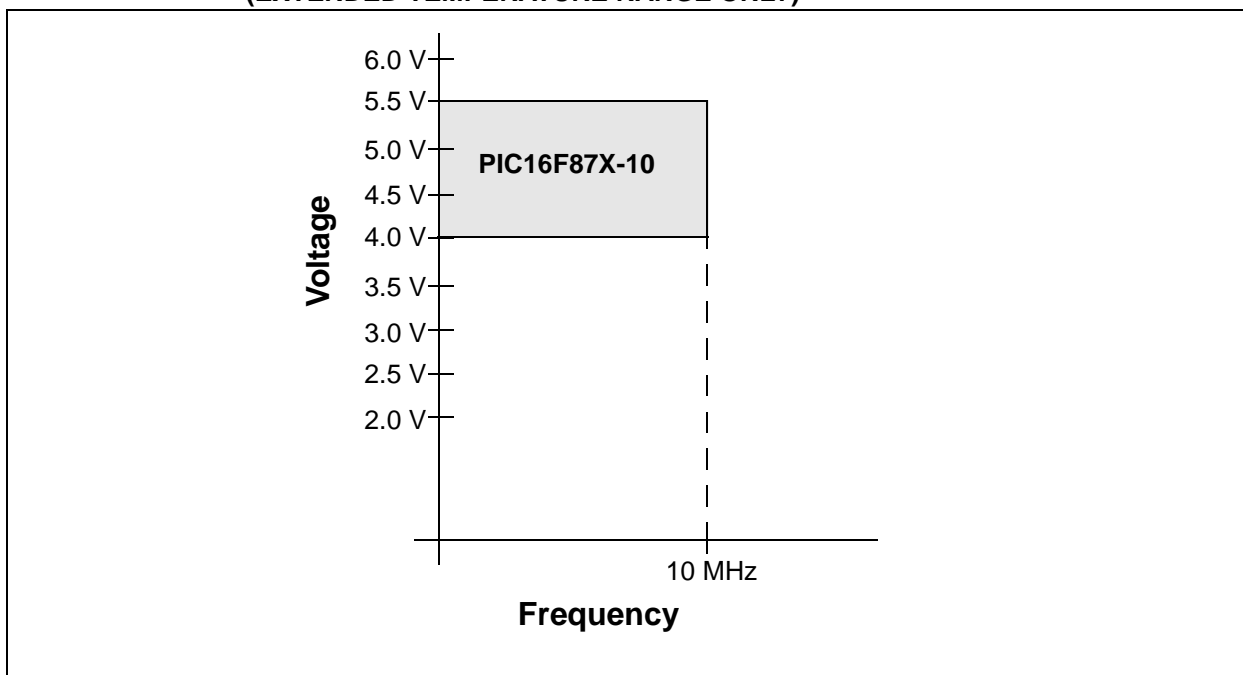


FIGURE 15-4: PIC16F87X-10 VOLTAGE-FREQUENCY GRAPH (EXTENDED TEMPERATURE RANGE ONLY)



15.3 DC Characteristics: PIC16F873/874/876/877-04 (Extended) PIC16F873/874/876/877-10 (Extended)

PIC16F873/874/876/877-04 PIC16F873/874/876/877-20 (Extended)			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$				
Param No.	Symbol	Characteristic/ Device	Min	Typ†	Max	Units	Conditions
D001 D001A D001A	VDD	Supply Voltage					
			4.0	—	5.5	V	LP, XT, RC osc configuration
			4.5		5.5	V	HS osc configuration
			VBOR		5.5	V	BOR enabled, FMAX = 10 MHz ⁽⁷⁾
D002	VDR	RAM Data Retention Voltage⁽¹⁾	—	1.5	—	V	
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	—	VSS	—	V	See section on Power-on Reset for details
D004	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.05	—	—	V/ms	See section on Power-on Reset for details
D005	VBOR	Brown-out Reset Voltage	3.7	4.0	4.35	V	BODEN bit in configuration word enabled

† Data is "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading, switching rate, oscillator type, internal code execution pattern and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{EXT}$ (mA) with REXT in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

7: When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.

PIC16F87X

FIGURE 15-13: SPI MASTER MODE TIMING (CKE = 0, SMP = 0)

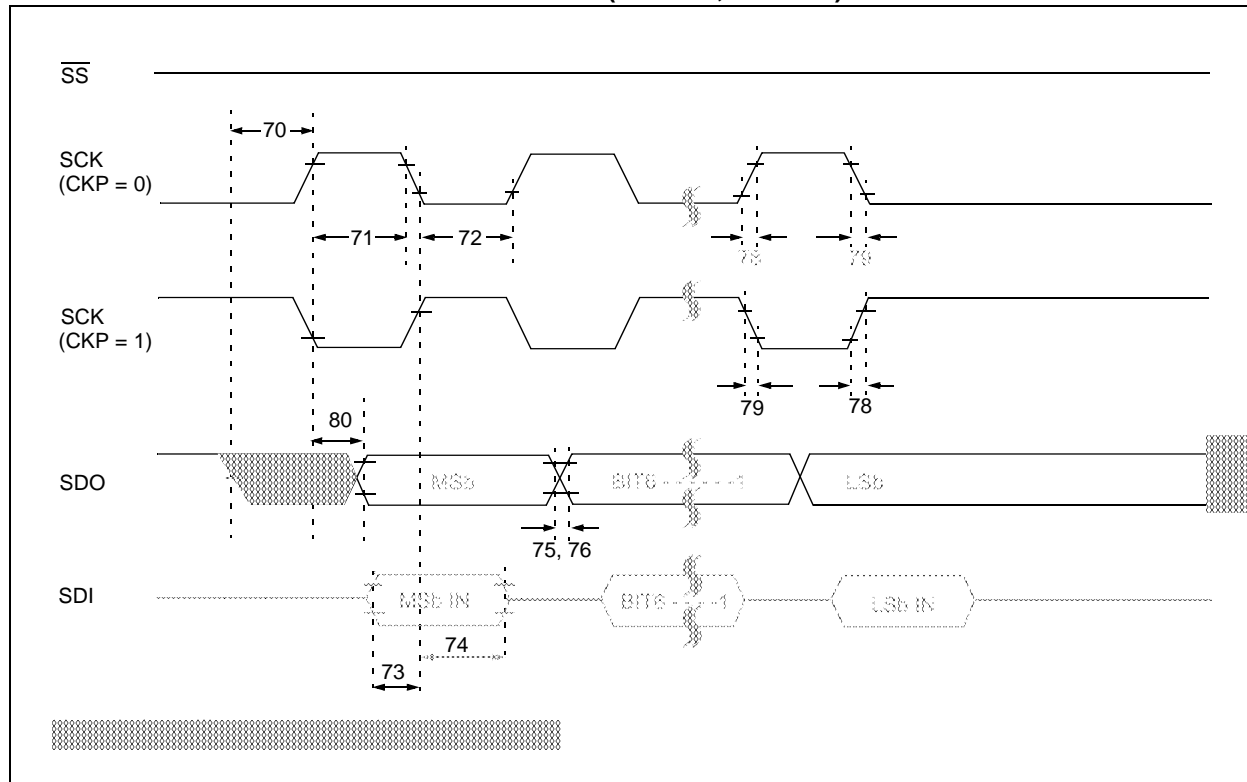
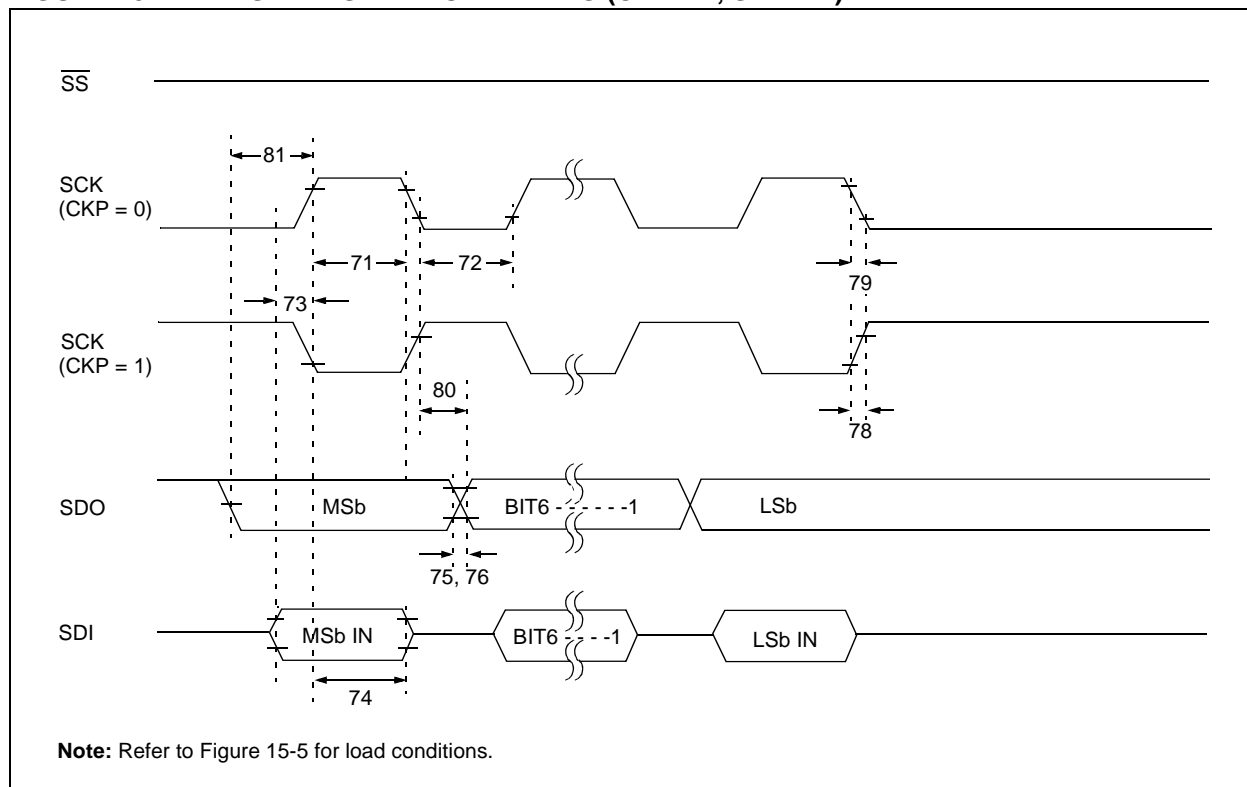


FIGURE 15-14: SPI MASTER MODE TIMING (CKE = 1, SMP = 1)



PIC16F87X

NOTES:

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FIGURE 16-19: TYPICAL, MINIMUM AND MAXIMUM V_{OL} vs. I_{OL} ($V_{DD}=3V$, $-40^{\circ}C$ TO $125^{\circ}C$)

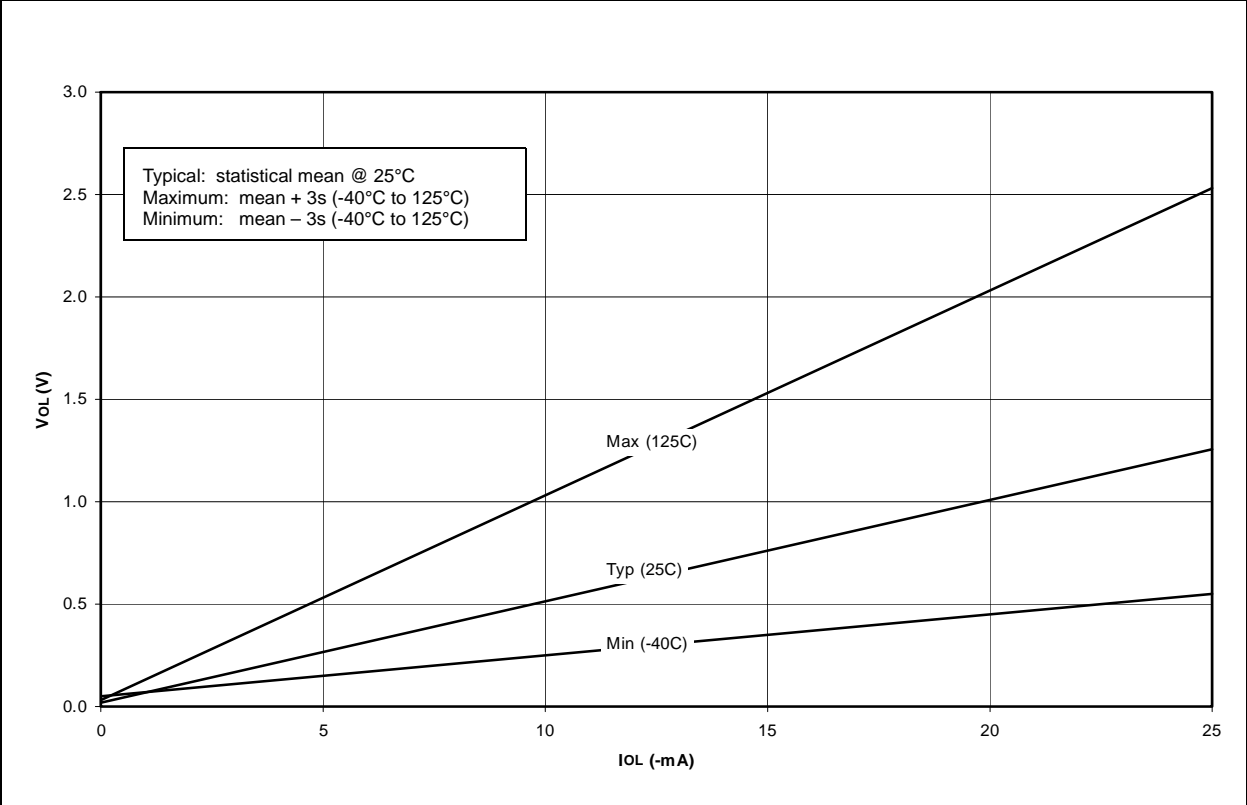
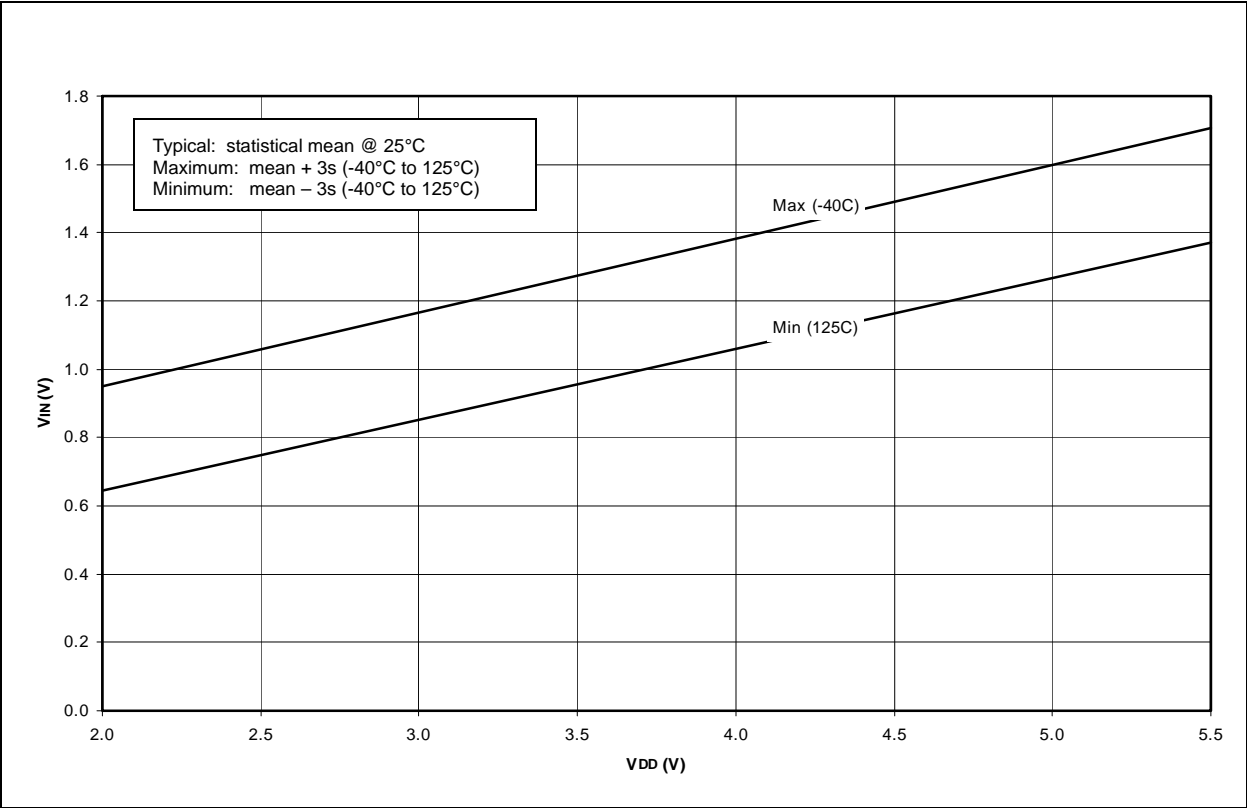


FIGURE 16-20: MINIMUM AND MAXIMUM V_{IN} vs. V_{DD} , (TTL INPUT, $-40^{\circ}C$ TO $125^{\circ}C$)

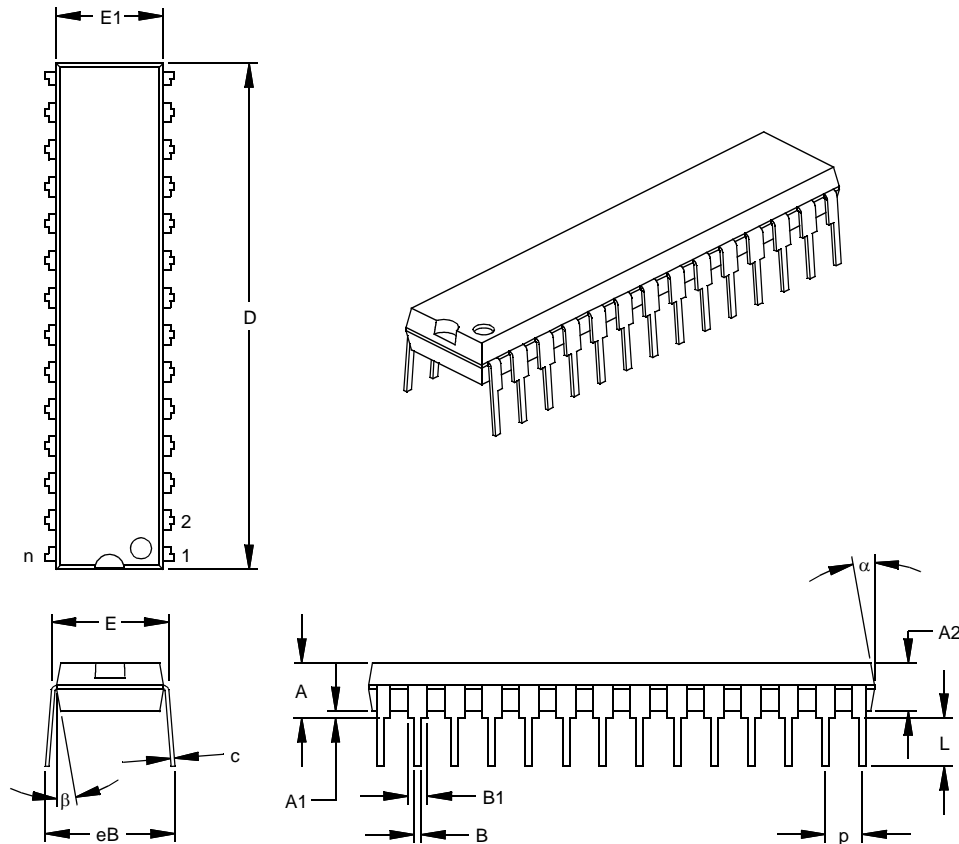


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NOTES:

28-Lead Skinny Plastic Dual In-line (SP) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.310	.325	7.62	7.87	8.26
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	B	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing	§ eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-095

Drawing No. C04-070

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